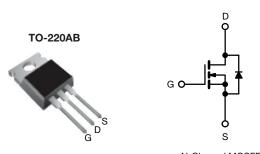
Vishay Siliconix

COMPLIANT

HALOGEN

FREE

EF Series Power MOSFET With Fast Body Diode

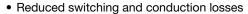


N-Channel	MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V	0.061		
Q _g max. (nC)	189			
Q _{gs} (nC)	26			
Q _{gd} (nC)	55			
Configuration	Single			

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)



- Ultra low gate charge (Qa)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP38N60EF-GE3

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V_{DS}	600	V	
Gate-source voltage			V_{GS}	± 30	v	
Continuous drain current (T _J = 150 °C)	V at 10 V	T _C = 25 °C T _C = 100 °C	,	40	А	
	V _{GS} at 10 V	T _C = 100 °C	I _D	25		
Pulsed drain current ^a			I _{DM}	111		
Linear derating factor				2.5	W/°C	
Single pulse avalanche energy b			E _{AS}	508	mJ	
Maximum power dissipation			P_{D}	313	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	$T_{J} = $	T _J = 125 °C		70	1//20	
Reverse diode dv/dt ^d			dv/dt	50	V/ns	
Soldering recommendations (peak temperature) c	For 10 s			260	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 6.0 A
- c. 1.6 mm from case
- d. $I_{SD} = 23.5$ A, di/dt = 250 A/ μ s, starting $T_J = 25$ °C

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum junction-to-ambient	R _{thJA}	-	40	°C/W		
Maximum junction-to-case (drain)	R _{thJC}	-	0.4	C/ VV		



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PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V _{DS}	V _{GS} =	600	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I _D = 10 mA		-	0.72	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$		2	-	4	V
Cata aguirea laglaga		V _{GS} = ± 20 V		-	-	± 100	nA
Gate-source leakage	I_{GSS}	,	$V_{GS} = \pm 30 \text{ V}$	=	-	± 1	μA
Zoro goto voltago droin ourrent	1	V _{DS} =	480 V, V _{GS} = 0 V	-	-	1	μA
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	2	mA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 23.5 A	-	0.061	0.070	Ω
Forward transconductance ^a	9fs	V _{DS} =	30 V, I _D = 23.5 A	-	13	-	S
Dynamic							
Input capacitance	C _{iss}	V _{GS} = 0 V,		-	3576	-	pF
Output capacitance	C _{oss}	,	$V_{DS} = 100 \text{ V},$		167	-	
Reverse transfer capacitance	C _{rss}	f = 1 MHz		-	5	-	
Effective output capacitance, energy related ^a	C _{o(er)}	V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	104	-	
Effective output capacitance, time related ^b	C _{o(tr)}			-	535	-	
Total gate charge	Qg			-	126	189	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 23.5 \text{ A}, V_{DS} = 480 \text{ V}$		26	-	nC
Gate-drain charge	Q _{gd}			-	55	-	
Turn-on delay time	t _{d(on)}			-	35	70	
Rise time	t _r	$V_{DD} = 480 \text{ V}, I_{D} = 23.5 \text{ A},$ $V_{GS} = 10 \text{ V}, R_{g} = 9.1 \Omega$		-	63	126	
Turn-off delay time	t _{d(off)}			-	143	286	ns
Fall time	t _f			-	67	134	
Gate input resistance	R_g	f = 1 MHz, open drain		0.2	0.5	1.0	Ω
Drain-Source Body Diode Characteristic	cs						
Continuous source-drain diode current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	40	
Pulsed diode forward current	I _{SM}			-	-	111	A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 23.5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}	-		-	160	320	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 23.5 \text{ A},$ di/dt = 100 A/ μ s, $V_R = 400 \text{ V}$		_	1.2	2.4	μC
Reverse recovery current	I _{RRM}			-	14.3	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

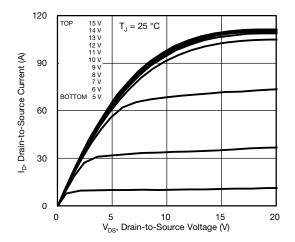


Fig. 1 - Typical Output Characteristics

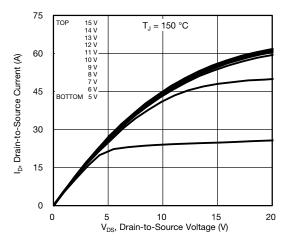


Fig. 2 - Typical Output Characteristics

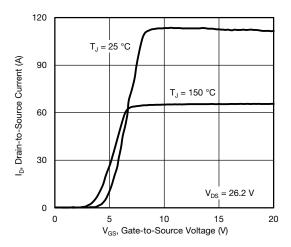


Fig. 3 - Typical Transfer Characteristics

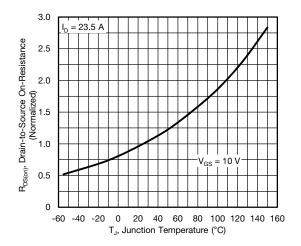


Fig. 4 - Normalized On-Resistance vs. Temperature

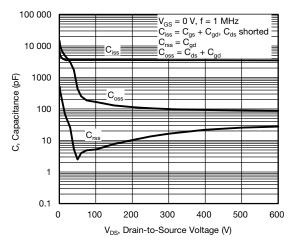


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

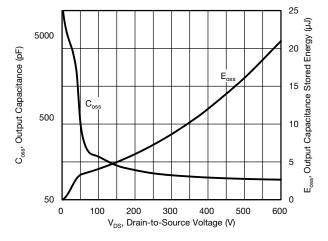


Fig. 6 - Coss and Eoss vs. VDS



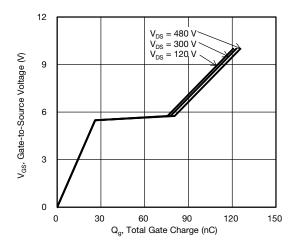


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

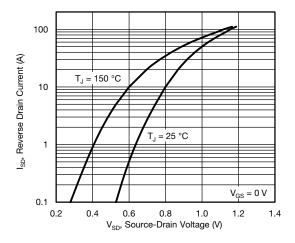


Fig. 8 - Typical Source-Drain Diode Forward Voltage

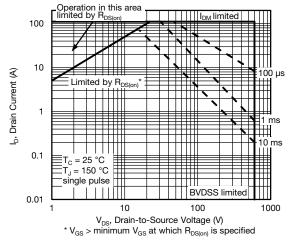


Fig. 9 - Maximum Safe Operating Area

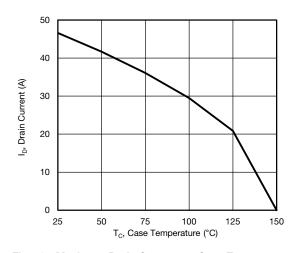


Fig. 10 - Maximum Drain Current vs. Case Temperature

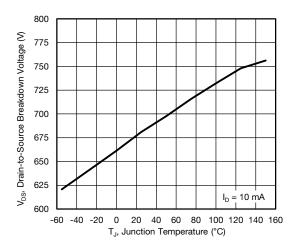


Fig. 11 - Temperature vs. Drain-to-Source Voltage



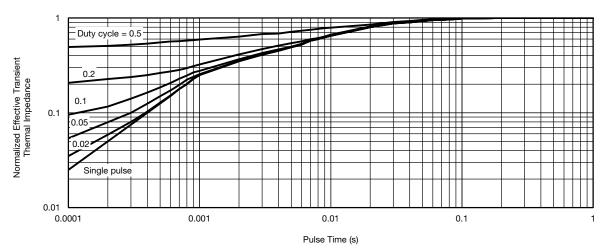


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

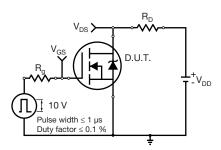


Fig. 13 - Switching Time Test Circuit

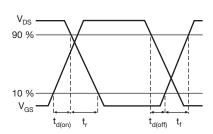


Fig. 14 - Switching Time Waveforms

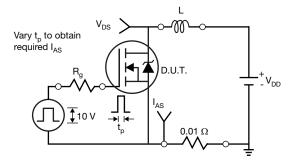


Fig. 15 - Unclamped Inductive Test Circuit

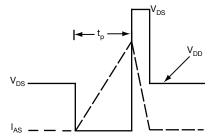


Fig. 16 - Unclamped Inductive Waveforms

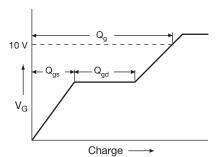


Fig. 17 - Basic Gate Charge Waveform

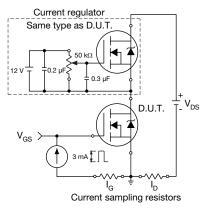
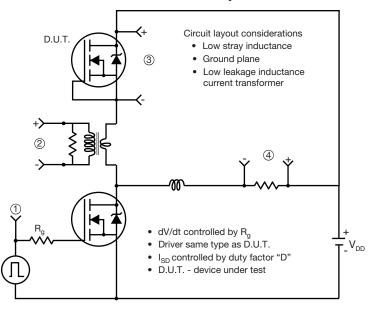


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



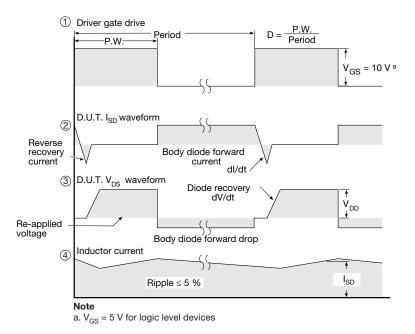


Fig. 19 - For N-Channel

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